# mail

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### DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 Feb 20 2004 Dec 09



### FEATURES

- High current (max. 0.5 A)
- Low voltage (max. 80 V)
- Integrated diode and resistor.

### **APPLICATIONS**

- Industrial switching applications such as:
  - Print hammer
  - Solenoid
  - Relay and lamp driving.

### DESCRIPTION

NPN Darlington transistor in a SOT89 plastic package. PNP complements: BST60, BST61 and BST62.

#### MARKING

TYPE NUMBER	MARKING CODE
BST50	AS1
BST51	AS2
BST52	AS3

### BST50; BST51; BST52

### PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	



#### **ORDERING INFORMATION**

		PACKAGE	
I TPE NUMBER	NAME	DESCRIPTION	VERSION
BST50	SC-62	plastic surface mounted package; collector pad for good heat	SOT89
BST51		transfer; 3 leads	
BST52			

### BST50; BST51; BST52

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	BOL PARAMETER CONDITIONS		MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter			
	BST50		_	60	V
	BST51		_	80	V
	BST52		_	90	V
V <sub>CES</sub>	collector-emitter voltage	V <sub>BE</sub> = 0 V			
	BST50		_	45	V
	BST51		_	60	V
	BST52		-	80	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current (DC)		-	1	А
I <sub>CM</sub>	peak collector current		-	2	А
I <sub>B</sub>	base current (DC)		-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	-	1.3	W
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

#### Note

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>. For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	note 1	96	K/W
R <sub>th(j-s)</sub>	thermal resistance from junction to soldering point		16	K/W

#### Note

1. Device mounted on a printed-circuit board, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>. For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

### BST50; BST51; BST52

### CHARACTERISTICS

 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	IBOL PARAMETER CONDITIONS		MIN.	TYP.	MAX.	UNIT
I <sub>CES</sub>	collector-emitter cut-off current					
	BST50	$V_{BE} = 0 V; V_{CE} = 45 V$	_	-	50	nA
	BST51	$V_{BE} = 0 V; V_{CE} = 60 V$	-	-	50	nA
	BST52	$V_{BE} = 0 V; V_{CE} = 80 V$	_	_	50	nA
I <sub>EBO</sub>	emitter-base cut-off current	$I_{C} = 0 A; V_{EB} = 4 V$	_	—	50	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 10 V; note 1; (see Fig.2)				
		I <sub>C</sub> = 150 mA	1000	-	-	
		I <sub>C</sub> = 500 mA	2000	-	_	
V <sub>CEsat</sub>	collector-emitter saturation	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 0.5 mA	—	-	1.3	V
voltage		I <sub>C</sub> = 500 mA; I <sub>B</sub> = 0.5 mA; T <sub>j</sub> = 150 °C	_	_	1.3	V
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 0.5 mA	-	-	1.9	V
f <sub>T</sub>	transition frequency	$I_{C} = 500 \text{ mA}; V_{CE} = 5 \text{ V};$ f = 100 MHz	-	200	-	MHz
Switching times (between 10% and 90% levels); (see Fig.3)						
t <sub>on</sub>	turn-on time	$I_{Con} = 500 \text{ mA}; I_{Bon} = 0.5 \text{ mA};$ $I_{Boff} = -0.5 \text{ mA}$	_	400	_	ns
t <sub>off</sub>	turn-off time		-	1 500	-	ns

#### Note

1. Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02$ .

### BST50; BST51; BST52





### BST50; BST51; BST52

### PACKAGE OUTLINE



### BST50; BST51; BST52

#### DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
1	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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